

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8\text{ V}$  at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $> 2\text{ V}$  at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model ( $C = 200\text{ pF}$ ,  $R = 0$ )
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- All Outputs Have Equivalent 26- $\Omega$  Series Resistors, So No External Resistors Are Required
- Package Options Include Plastic Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

## description

This 16-bit (dual-octal) noninverting bus transceiver is designed for 2.7-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCR162245 is designed for asynchronous communication between data buses. The control function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so that the buses are effectively isolated.

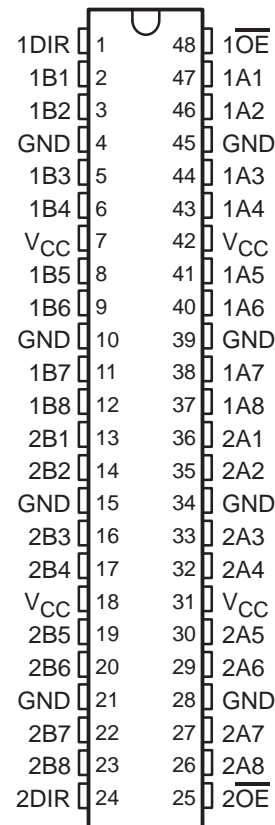
All outputs, which are designed to sink up to 12 mA, include 26- $\Omega$  resistors to reduce overshoot and undershoot.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVCR162245 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

**DGG OR DL PACKAGE**  
(TOP VIEW)



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SN74LVCR162245
16-BIT BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

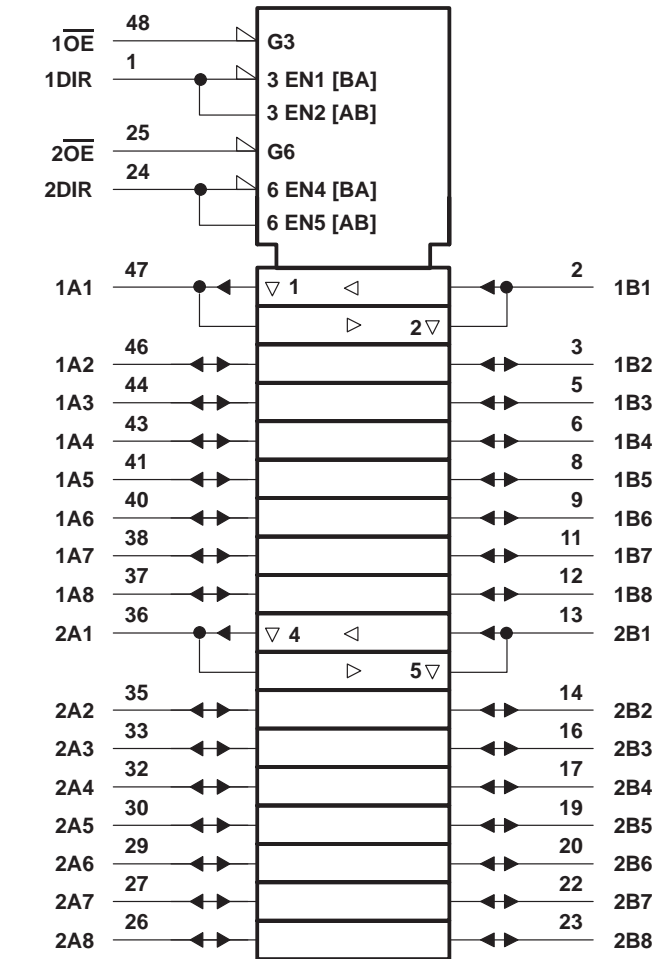
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FUNCTION TABLE

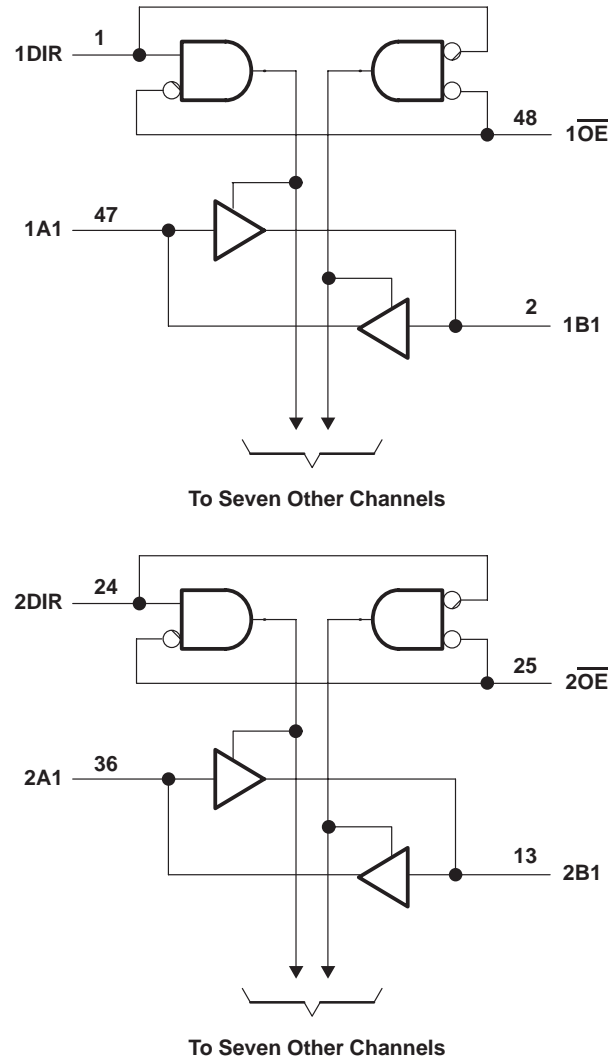
(each 8-bit section)

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$	−0.5 V to 4.6 V
Input voltage range, $V_I$ : Except I/O ports (see Note 1)	−0.5 V to $V_{CC} + 4.6$ V
I/O ports (see Notes 1 and 2)	−0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Notes 1 and 2)	−0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	−50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±50 mA
Continuous current through $V_{CC}$ or GND	±100 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): DGG package	0.85 W
DL package	1.2 W
Storage temperature range, $T_{stg}$	−65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. This value is limited to 4.6 V maximum.  
3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

**recommended operating conditions (see Note 4)**

			MIN	MAX	UNIT
$V_{CC}$	Supply voltage		2.7	3.6	V
$V_{IH}$	High-level input voltage	$V_{CC} = 2.7$ V to 3.6 V	2		V
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.7$ V to 3.6 V		0.8	V
$V_I$	Input voltage		0	$V_{CC}$	V
$V_O$	Output voltage		0	$V_{CC}$	V
$I_{OH}$	High-level output current	$V_{CC} = 2.7$ V		−8	mA
		$V_{CC} = 3$ V		−12	
$I_{OL}$	Low-level output current	$V_{CC} = 2.7$ V		8	mA
		$V_{CC} = 3$ V		12	
$\Delta t/\Delta V$	Input transition rise or fall rate		0	10	ns/V
$T_A$	Operating free-air temperature		−40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.

**SN74LVCR162245**  
**16-BIT BUS TRANSCEIVER**  
**WITH 3-STATE OUTPUTS**

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub> <sup>†</sup>	MIN	TYP <sup>‡</sup>	MAX	UNIT
V <sub>OH</sub>	I <sub>OH</sub> = -100 µA	MIN to MAX	V <sub>CC</sub> - 0.2			V
	I <sub>OH</sub> = -4 mA, V <sub>IH</sub> = 2 V	2.7 V	2.2			
	I <sub>OH</sub> = -8 mA, V <sub>IH</sub> = 2 V	2.7 V	2			
	I <sub>OH</sub> = -6 mA, V <sub>IH</sub> = 2 V	3 V	2.4			
	I <sub>OH</sub> = -12 mA, V <sub>IH</sub> = 2 V	3 V	2			
V <sub>OL</sub>	I <sub>OH</sub> = -100 µA	MIN to MAX	0.2			V
	I <sub>OH</sub> = -4 mA, V <sub>IL</sub> = 0.8 V	2.7 V	0.4			
	I <sub>OH</sub> = -8 mA, V <sub>IL</sub> = 0.8 V	2.7 V	0.6			
	I <sub>OH</sub> = -6 mA, V <sub>IL</sub> = 0.8 V	3 V	0.55			
	I <sub>OH</sub> = -12 mA, V <sub>IL</sub> = 0.8 V	3 V	0.8			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V	±5			µA
I <sub>I</sub> (hold)	V <sub>I</sub> = 0.8 V	3 V	75			µA
	V <sub>I</sub> = 2 V		-75			
	V <sub>I</sub> = 0 to 3.6 V	3.6 V	±500			µA
I <sub>OZ</sub> <sup>§</sup>	V <sub>O</sub> = V <sub>CC</sub> or GND	3.6 V	±10			µA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	3.6 V	20			µA
ΔI <sub>CC</sub>	One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	2.7 V to 3.6 V	500			µA
C <sub>i</sub>	Control inputs V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	2.5			pF
C <sub>io</sub>	A or B ports V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V	3.5			pF

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

<sup>§</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

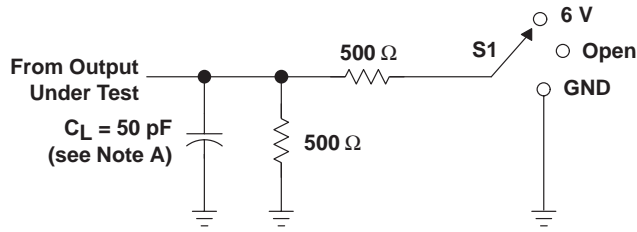
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		UNIT
			MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	1.5	7.5	1.5	8.5	ns
t <sub>en</sub>	$\overline{\text{OE}}$	A or B	1.5	9	1.5	10	ns
t <sub>dis</sub>	$\overline{\text{OE}}$	A or B	1.5	7.5	1.5	8.5	ns

**operating characteristics, V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C**

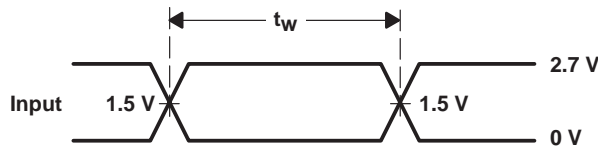
PARAMETER		TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per transceiver	C <sub>L</sub> = 50 pF, f = 10 MHz	20	pF
	Outputs enabled		2	



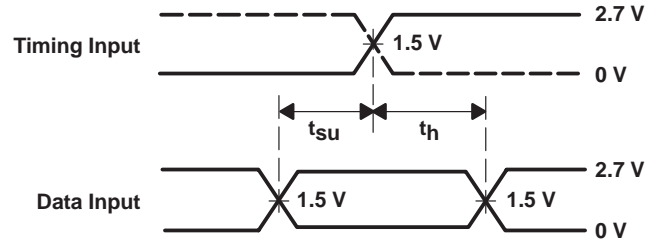
## PARAMETER MEASUREMENT INFORMATION



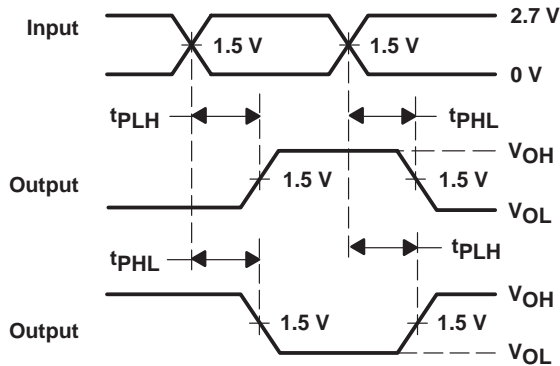
LOAD CIRCUIT FOR OUTPUTS



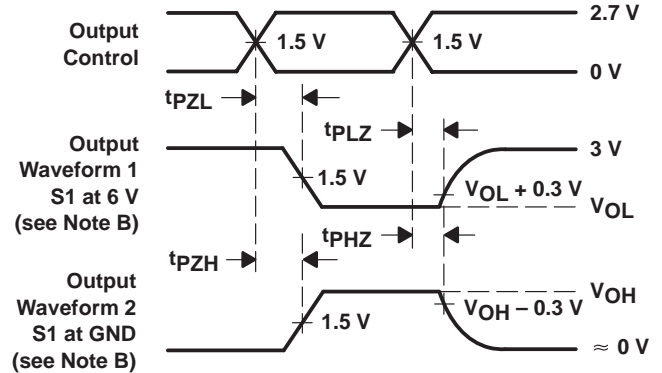
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

NOTES: A.  $C_L$  includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .

D. The outputs are measured one at a time with one transition per measurement.

E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .

F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{den}$ .

G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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